



SYMBOL	MIN	NOM	MAX
A	1.35	1.50	1.65
A1	0.05	0.10	0.15
A2	1.35	1.40	1.50
A3	0.50	0.60	0.7
b	0.38	-	0.50
D	4.80	4.90	5.00
e	1.27BSC		
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
L	0.45	0.60	0.80
L1	1.04REF		
L2	0.25BSC		
R	0.07	--	--
R1	0.07	--	--
h	0.30	0.40	0.50
theta	0°	--	8°
theta 1	10°	12°	14°
theta 2	8°	10°	12°
theta 3	10°	12°	14°
theta 4	8°	10°	12°

NOTES:  
 1. ALL DIMENSIONS REFER TO JEDEC STANDARD MO-137E  
 2. DIMENSION D DOES NOT INCLUDE MOLD FLASH  
 3. DIMENSION E1 DOES NOT INCLUDE MOLD FLASH  
 4. FLASH OR PROTRUSION SHALL NOT EXCEED 0.25mm PER SIDE.

 <b>上海季丰电子科技有限公司</b> GIGA FORCE ELECTRONICS CO., Limited			
制图	王磊	Title	Package Outline SOP7
核准	何桂港	POD No	POD-SHJF-32
日期	2022. 3. 31	DIMENSIONS IN:	mm Rev: A